

AEC-Q200 This component was always RoHS compliant from the first date of manufacture.

**RoHS** 

Compliant

SF2024D

# 467.751 MHz **SAW Filter**



• Designed for SDARS Receiver IF Application

· Low Insertion Loss

• 3.8 X 3.8 X 1.2 mm Surface-Mount Case

• Differential Input and Output

• Complies with Directive 2002/95/EC (RoHS)

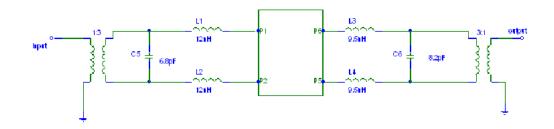
**Absolute Maximum Ratings** 

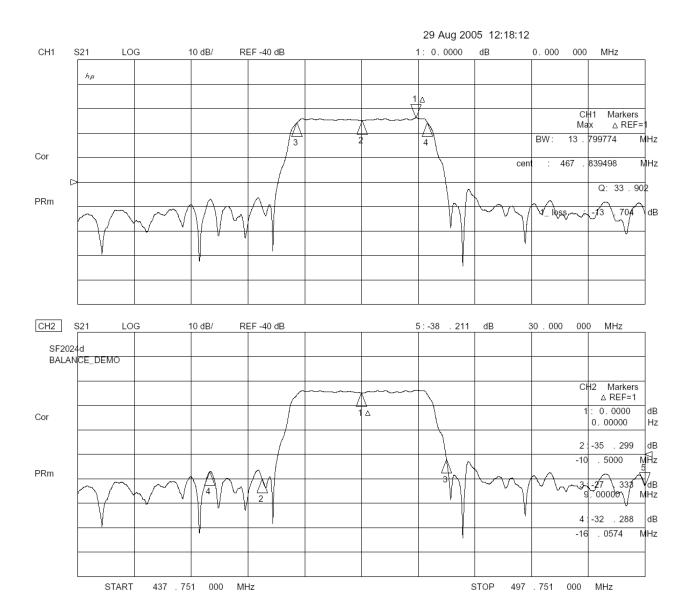
Rating	Value	Units	
Maximum Incident Power in Passband	+10	dBm	
Max. DC voltage between any 2 terminals	30	VDC	
Storage Temperature Range	-40 to +85	°C	
Suitable for lead-free soldering - Max Soldering Profile	260°C	260°C for 30 s	

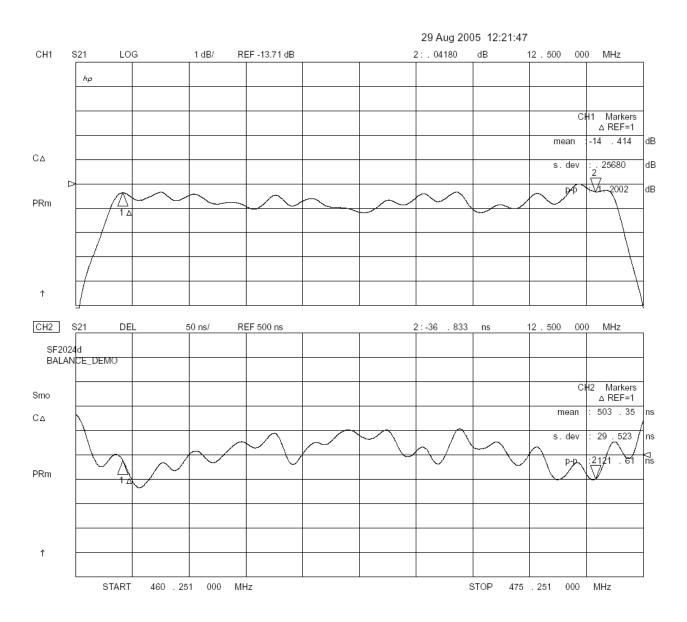
Characteristic		Sym	Notes	Min	Тур	Max	Units
Center Frequency		f <sub>C</sub>		467.704	467.751	467.798	MHz
Insertion Loss		IL	•		12	13	dB
Amplitude Ripple (p-p)	fc-6.250 to fc-4.3925 MHz					2.0	dB
	fc-4.3925 to fc-2.535 MHz					2.0	
	fc-2.5350 to fc-0.025 MHz					2.0	
	fc+0.025 to fc+2.535 MHz					2.0	
	fc+2.5350 to fc+4.3925 MHz					2.0	
	fc+4.3925 to fc+6.250 MHz					2.0	
Pass bandwidth of -2.0dB centered at fc					13.0		MHz
Pass bandwidth of -3 dB							IVIIIZ
Low Side Attenuation between 455.751 to 457.251 MHz (fc-10.5 MHz)				32			dB
Low Side Attenuation F<455.751 MHz				32			
High Side Attenuation between 476.751 to 479.751 MHz (fc+9.0 MHz)				20			
High Side Attenuation F>479.75	1 MHz			32			
Temperature Coefficient of frequ	ency					-18	ppm/K
Delay Ripple (p-p)	fc-6.250 to fc-4.3925 MHz					100	
	fc-4.3925 to fc-2.535 MHz					100	ns
	fc-2.5350 to fc-0.025 MHz					120	
	fc+0.025 to fc+2.535 MHz					120	
	fc+2.5350 to fc+4.3925 MHz					100	
	fc+4.3925 to fc+6.250 MHz					100	
Source Impedance		ZS			150		Ω
Load Impedance		ZL			150		Ω
Case Style				SM3838-	SM3838-8 3.8 x 3.8 mm Nominal Footprint		
Lid Symbolization (YY=year, WW=week, S=shift)					380 <u>YW</u>	WS	

## **CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.** NOTES:

- 1. The design, manufacturing process, and specifications of this device are subject to change.
- 2. US or International patents may apply.
- 3. RoHS compliant from the first date of manufacture.

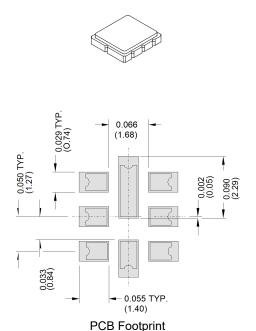






# SM3838-8 Case

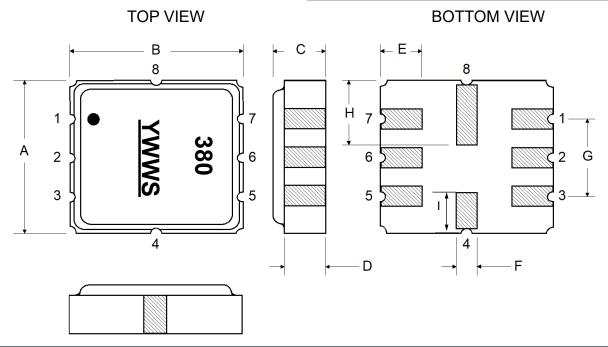
# 8-Terminal Ceramic Surface-Mount Case 3.8 X 3.8 mm Nominal Footprint



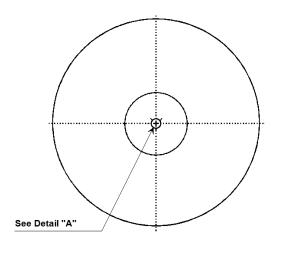
Case Dimensions						
Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
Α	3.6	3.8	4.0	0.142	0.150	0.157
В	3.6	3.8	4.0	0.142	0.150	0.157
С	1.05	1.20	1.35	0.041	0.047	0.053
D	0.95	1.10	1.25	0.037	0.043	0.049
E	0.90	1.00	1.10	0.035	0.040	0.043
F	0.50	0.60	0.70	0.020	0.024	0.028
G	2.39	2.54	2.69	0.090	0.100	0.110
Н	1.40	1.75	2.05	0.055	0.069	0.080
I	0.90	1.00	1.10	0.035	0.040	0.043

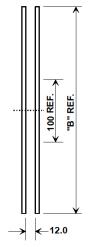
Electrical Connections				
	Connection Terminals			
Port 1	Differential Input	1, 2		
Port 2	Differential Output	5, 6		
	Ground	All Others		
Single Ended Operation		Return is Ground		
Differential Operation		Return is Hot		
Dot Indicates Pin 1				

Materials				
Solder Pad Termination	Au plating 30 - 60 ulnches (76.2-152 uM) over 80-200 ulnches (203-508 uM) Ni.			
Lid	Fe-Ni-Co Alloy Electroless Nickel Plate (8-11% Phosphorus) 100-200 ulnches Thick			
Body	Al <sub>2</sub> O <sub>3</sub> Ceramic			
Pb Free				



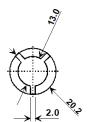
# **Tape and Reel Specifications**





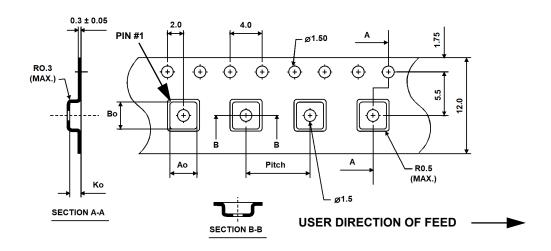
Tape and Reel Standard per ANSI/EIA-481

"B " Nominal Size		Quantity Per Reel
Inches	millimeters	
7	178	500
13	330	3000



### **COMPONENT ORIENTATION and DIMENSIONS**

Carrier Tape Dimensions				
Ao	4.25 mm			
Во	4.25 mm			
Ко	1.30 mm			
Pitch	8.0 mm			
W	12.0 mm			



### **Recommended Reflow Profile**

- 1. Preheating shall be fixed at 150~180°C for 60~90 seconds.
- 2. Ascending time to preheating temperature 150°C shall be 30 seconds min.
- 3. Heating shall be fixed at 220°C for 50~80 seconds and at 260°C +0/-5°C peak (10 seconds).
- 4. Time: 5 times maximum.

